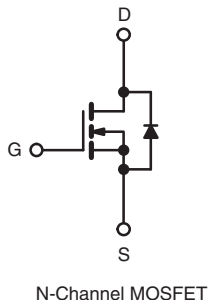
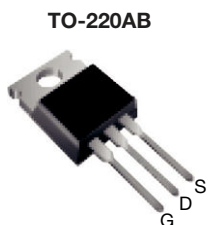


## D Series Power MOSFET

| PRODUCT SUMMARY                         |                 |     |
|-----------------------------------------|-----------------|-----|
| $V_{DS}$ (V) at $T_J$ max.              | 450             |     |
| $R_{DS(on)}$ max. at 25 °C ( $\Omega$ ) | $V_{GS} = 10$ V | 1.0 |
| $Q_g$ max. (nC)                         | 18              |     |
| $Q_{gs}$ (nC)                           | 3               |     |
| $Q_{gd}$ (nC)                           | 4               |     |
| Configuration                           | Single          |     |



### FEATURES

- Optimal Design
  - Low Area Specific On-Resistance
  - Low Input Capacitance ( $C_{iss}$ )
  - Reduced Capacitive Switching Losses
  - High Body Diode Ruggedness
  - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
  - Low Cost
  - Simple Gate Drive Circuitry
  - Low Figure-of-Merit (FOM):  $R_{on} \times Q_g$
  - Fast Switching
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

### Note

\* Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

### APPLICATIONS

- Consumer Electronics
  - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies
  - SMPS
- Industrial
  - Welding
  - Induction Heating
- Motor Drives
- Battery Chargers



**RoHS\***  
COMPLIANT

| ORDERING INFORMATION |            |
|----------------------|------------|
| Package              | TO-220AB   |
| Lead (Pb)-free       | IRF730BPbF |

| ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted) |                         |                         |                                   |               |      |
|---------------------------------------------------------------------------|-------------------------|-------------------------|-----------------------------------|---------------|------|
| PARAMETER                                                                 |                         |                         | SYMBOL                            | LIMIT         | UNIT |
| Drain-Source Voltage                                                      |                         |                         | V <sub>DS</sub>                   | 400           | V    |
| Gate-Source Voltage                                                       |                         |                         | V <sub>GS</sub>                   | ± 30          |      |
| Gate-Source Voltage AC (f > 1 Hz)                                         |                         |                         |                                   | 30            |      |
| Continuous Drain Current (T <sub>J</sub> = 150 °C)                        | V <sub>GS</sub> at 10 V | T <sub>C</sub> = 25 °C  | I <sub>D</sub>                    | 6             | A    |
|                                                                           |                         | T <sub>C</sub> = 100 °C |                                   | 4             |      |
| Pulsed Drain Current <sup>a</sup>                                         |                         |                         | I <sub>DM</sub>                   | 13            |      |
| Linear Derating Factor                                                    |                         |                         |                                   | 0.8           | W/°C |
| Single Pulse Avalanche Energy <sup>b</sup>                                |                         |                         | E <sub>AS</sub>                   | 104           | mJ   |
| Maximum Power Dissipation                                                 |                         |                         | P <sub>D</sub>                    | 104           | W    |
| Operating Junction and Storage Temperature Range                          |                         |                         | T <sub>J</sub> , T <sub>stg</sub> | - 55 to + 150 | °C   |
| Drain-Source Voltage Slope                                                | T <sub>J</sub> = 125 °C |                         | dV/dt                             | 24            | V/ns |
| Reverse Diode dV/dt <sup>d</sup>                                          |                         | 0.48                    |                                   |               |      |
| Soldering Recommendations (Peak Temperature)                              | for 10 s                |                         |                                   | 300°          | °C   |

### Notes

- Repetitive rating; pulse width limited by maximum junction temperature.
- $V_{DD} = 50$  V, starting  $T_J = 25$  °C,  $L = 2.3$  mH,  $R_g = 25$   $\Omega$ ,  $I_{AS} = 9.5$  A.
- 1.6 mm from case.
- $I_{SD} \leq I_D$ , starting  $T_J = 25$  °C.

**THERMAL RESISTANCE RATINGS**

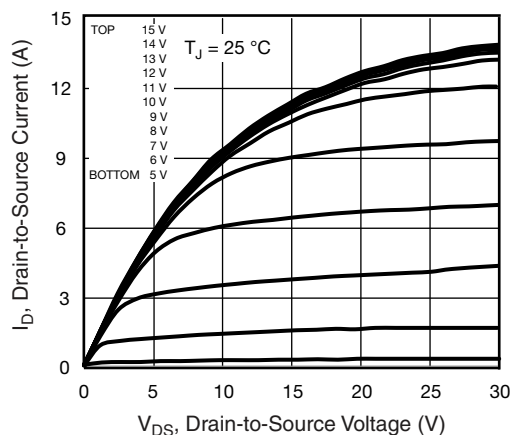
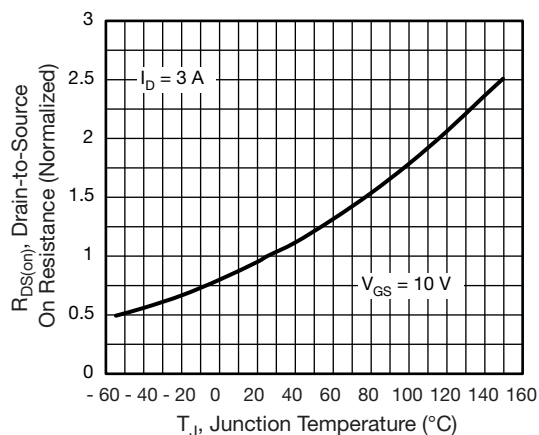
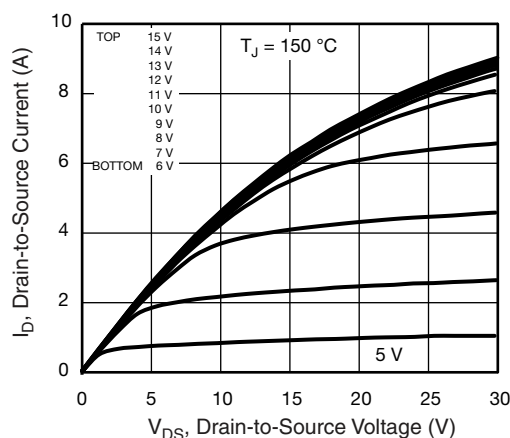
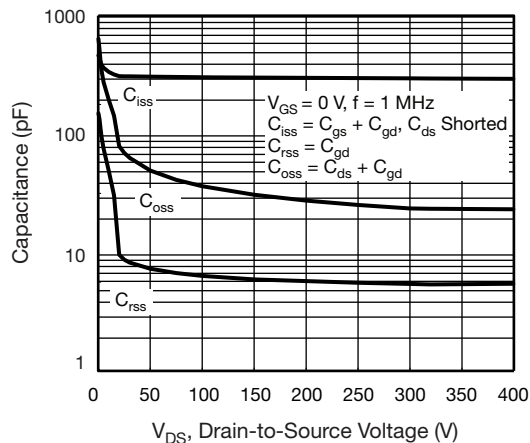
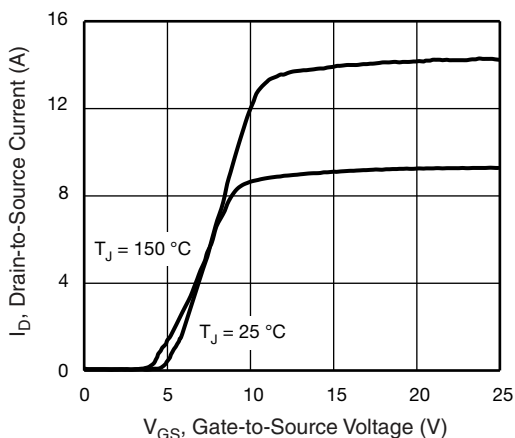
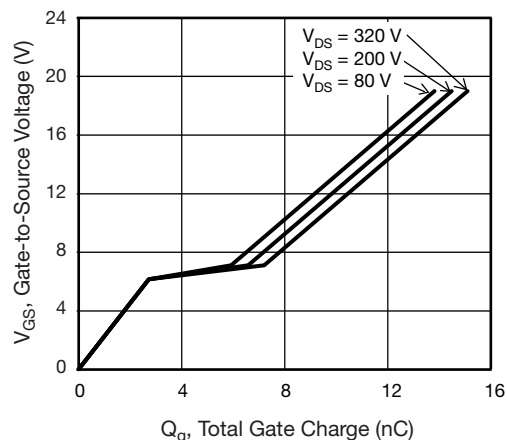
| PARAMETER                        | SYMBOL     | TYP. | MAX. | UNIT |
|----------------------------------|------------|------|------|------|
| Maximum Junction-to-Ambient      | $R_{thJA}$ | -    | 62   | °C/W |
| Maximum Junction-to-Case (Drain) | $R_{thJC}$ | -    | 1.2  |      |

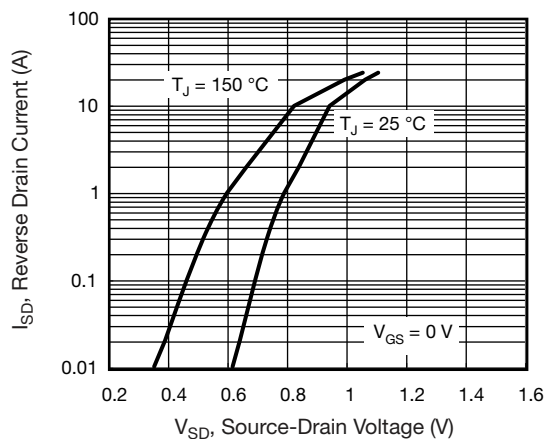
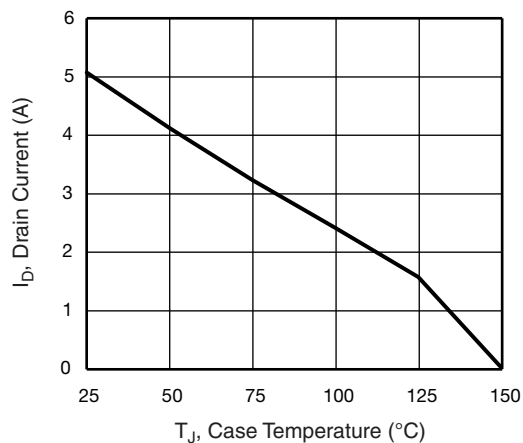
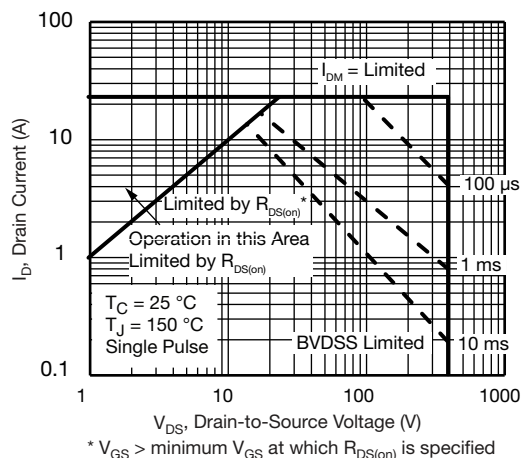
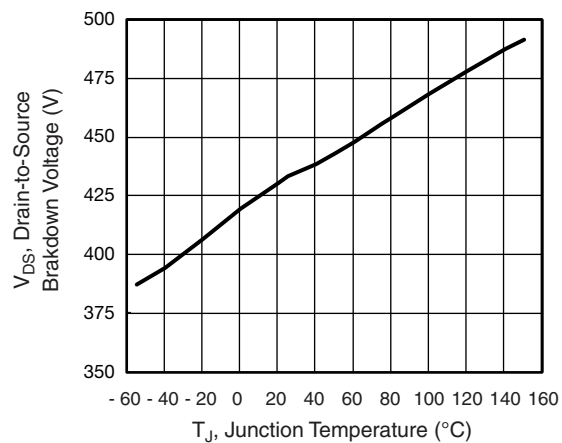
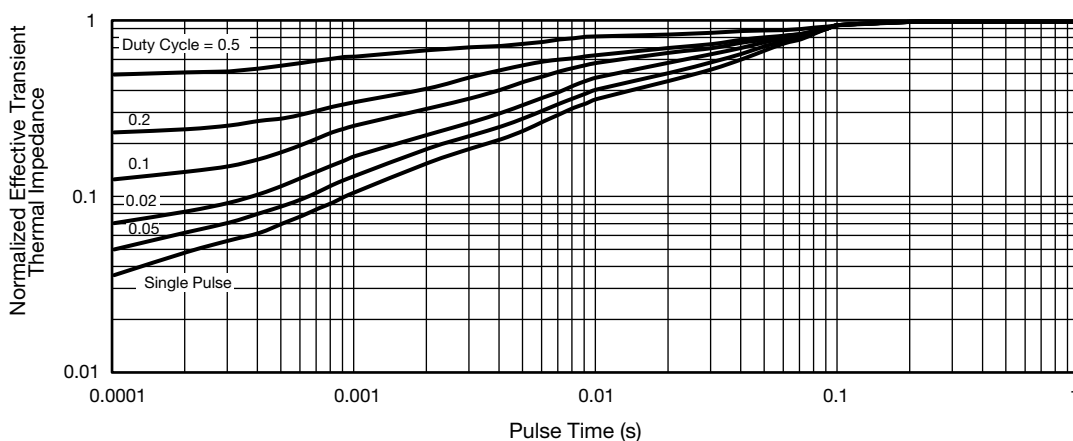
**SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

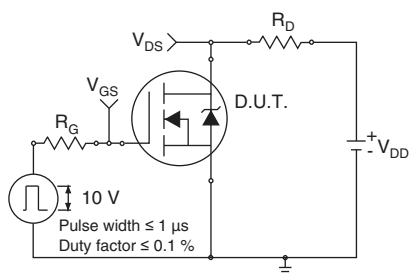
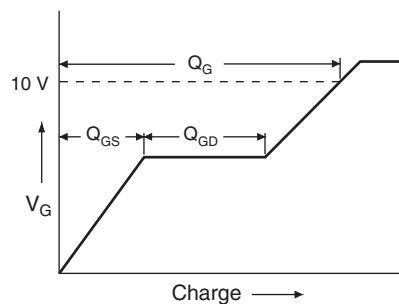
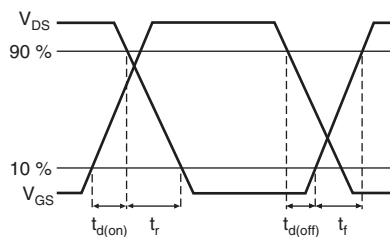
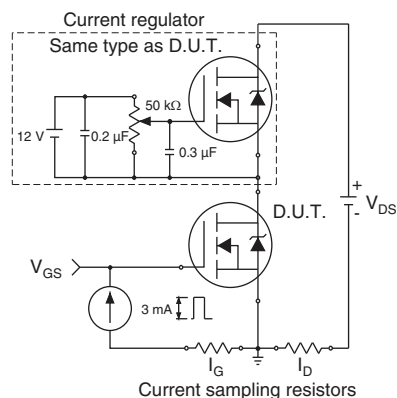
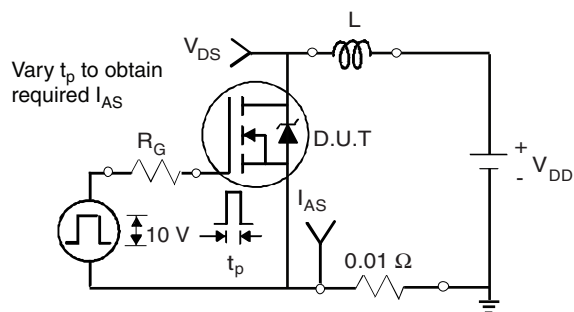
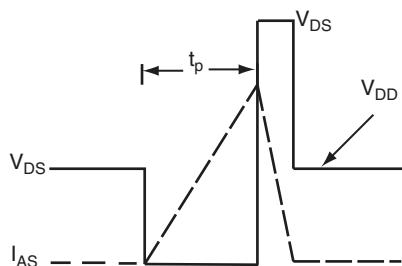
| PARAMETER                                                 | SYMBOL              | TEST CONDITIONS                                                                                                                                          |                                              | MIN. | TYP. | MAX.      | UNIT                |
|-----------------------------------------------------------|---------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------|------|------|-----------|---------------------|
| Static                                                    |                     |                                                                                                                                                          |                                              |      |      |           |                     |
| Drain-Source Breakdown Voltage                            | $V_{DS}$            | $V_{GS} = 0\text{ V}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                   |                                              | 400  | -    | -         | V                   |
| $V_{DS}$ Temperature Coefficient                          | $\Delta V_{DS}/T_J$ | Reference to $25\text{ }^\circ\text{C}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                 |                                              | -    | 0.53 | -         | V/ $^\circ\text{C}$ |
| Gate-Source Threshold Voltage (N)                         | $V_{GS(th)}$        | $V_{DS} = V_{GS}$ , $I_D = 250\text{ }\mu\text{A}$                                                                                                       |                                              | 3    | -    | 5         | V                   |
| Gate-Source Leakage                                       | $I_{GSS}$           | $V_{GS} = \pm 30\text{ V}$                                                                                                                               |                                              | -    | -    | $\pm 100$ | nA                  |
| Zero Gate Voltage Drain Current                           | $I_{DSS}$           | $V_{DS} = 400\text{ V}$ , $V_{GS} = 0\text{ V}$                                                                                                          |                                              | -    | -    | 1         | $\mu\text{A}$       |
|                                                           |                     | $V_{DS} = 320\text{ V}$ , $V_{GS} = 0\text{ V}$ , $T_J = 125\text{ }^\circ\text{C}$                                                                      |                                              | -    | -    | 10        |                     |
| Drain-Source On-State Resistance                          | $R_{DS(on)}$        | $V_{GS} = 10\text{ V}$                                                                                                                                   | $I_D = 3\text{ A}$                           | -    | 0.85 | 1.0       | $\Omega$            |
| Forward Transconductance                                  | $g_{fs}$            | $V_{DS} = 50\text{ V}$ , $I_D = 3\text{ A}$                                                                                                              |                                              | -    | 1.7  | -         | S                   |
| Dynamic                                                   |                     |                                                                                                                                                          |                                              |      |      |           |                     |
| Input Capacitance                                         | $C_{iss}$           | $V_{GS} = 0\text{ V}$ ,<br>$V_{DS} = 100\text{ V}$ ,<br>$f = 1\text{ MHz}$                                                                               |                                              | -    | 311  | -         | pF                  |
| Output Capacitance                                        | $C_{oss}$           |                                                                                                                                                          |                                              | -    | 38   | -         |                     |
| Reverse Transfer Capacitance                              | $C_{rss}$           |                                                                                                                                                          |                                              | -    | 7    | -         |                     |
| Effective output capacitance, energy related <sup>a</sup> | $C_{o(er)}$         | $V_{GS} = 0\text{ V}$ ,<br>$V_{DS} = 0\text{ V to } 320\text{ V}$                                                                                        |                                              | -    | 44   | -         | pF                  |
| Effective output capacitance, time related <sup>b</sup>   | $C_{o(tr)}$         |                                                                                                                                                          |                                              | -    | 54   | -         |                     |
| Total Gate Charge                                         | $Q_g$               | $V_{GS} = 10\text{ V}$                                                                                                                                   | $I_D = 3\text{ A}$ , $V_{DS} = 320\text{ V}$ | -    | 9    | 18        | nC                  |
| Gate-Source Charge                                        | $Q_{gs}$            |                                                                                                                                                          |                                              | -    | 3    | -         |                     |
| Gate-Drain Charge                                         | $Q_{gd}$            |                                                                                                                                                          |                                              | -    | 4    | -         |                     |
| Turn-On Delay Time                                        | $t_{d(on)}$         | $V_{DD} = 400\text{ V}$ , $I_D = 3\text{ A}$ ,<br>$V_{GS} = 10\text{ V}$ , $R_g = 9.1\text{ }\Omega$                                                     |                                              | -    | 12   | 24        | ns                  |
| Rise Time                                                 | $t_r$               |                                                                                                                                                          |                                              | -    | 11   | 22        |                     |
| Turn-Off Delay Time                                       | $t_{d(off)}$        |                                                                                                                                                          |                                              | -    | 14   | 28        |                     |
| Fall Time                                                 | $t_f$               |                                                                                                                                                          |                                              | -    | 8    | 16        |                     |
| Gate Input Resistance                                     | $R_g$               | f = 1 MHz, open drain                                                                                                                                    |                                              | -    | 1.9  | -         | $\Omega$            |
| Drain-Source Body Diode Characteristics                   |                     |                                                                                                                                                          |                                              |      |      |           |                     |
| Continuous Source-Drain Diode Current                     | $I_S$               | MOSFET symbol showing the integral reverse p - n junction diode<br> |                                              | -    | -    | 6         | A                   |
| Pulsed Diode Forward Current                              | $I_{SM}$            |                                                                                                                                                          |                                              | -    | -    | 24        |                     |
| Diode Forward Voltage                                     | $V_{SD}$            | $T_J = 25\text{ }^\circ\text{C}$ , $I_S = 3\text{ A}$ , $V_{GS} = 0\text{ V}$                                                                            |                                              | -    | -    | 1.2       | V                   |
| Reverse Recovery Time                                     | $t_{rr}$            | $T_J = 25\text{ }^\circ\text{C}$ , $I_F = I_S = 3\text{ A}$ ,<br>dI/dt = 100 A/ $\mu\text{s}$ , $V_R = 20\text{ V}$                                      |                                              | -    | 236  | -         | ns                  |
| Reverse Recovery Charge                                   | $Q_{rr}$            |                                                                                                                                                          |                                              | -    | 1.1  | -         | $\mu\text{C}$       |
| Reverse Recovery Current                                  | $I_{RRM}$           |                                                                                                                                                          |                                              | -    | 9    | -         | A                   |

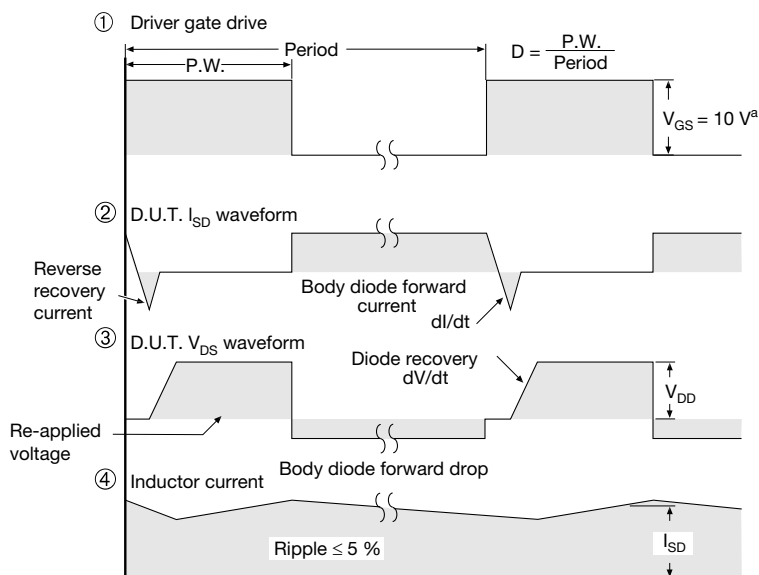
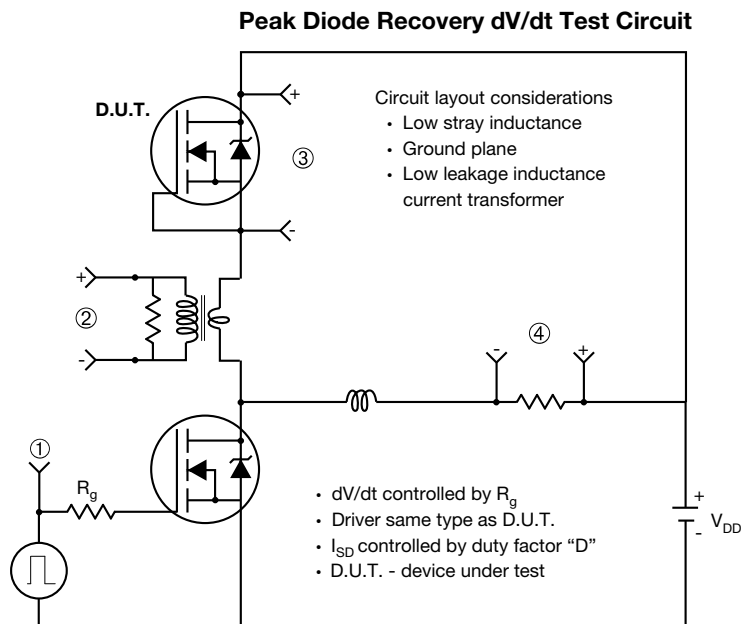
**Notes**

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .  
b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$ .

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

**Fig. 1 - Typical Output Characteristics**

**Fig. 4 - Normalized On-Resistance vs. Temperature**

**Fig. 2 - Typical Output Characteristics**

**Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage**

**Fig. 3 - Typical Transfer Characteristics**

**Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage**


**Fig. 7 - Typical Source-Drain Diode Forward Voltage**

**Fig. 9 - Maximum Drain Current vs. Case Temperature**

**Fig. 8 - Maximum Safe Operating Area**

**Fig. 10 - Temperature vs. Drain-to-Source Voltage**

**Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case**


**Fig. 12 - Switching Time Test Circuit**

**Fig. 16 - Basic Gate Charge Waveform**

**Fig. 13 - Switching Time Waveforms**

**Fig. 17 - Gate Charge Test Circuit**

**Fig. 14 - Unclamped Inductive Test Circuit**

**Fig. 15 - Unclamped Inductive Waveforms**

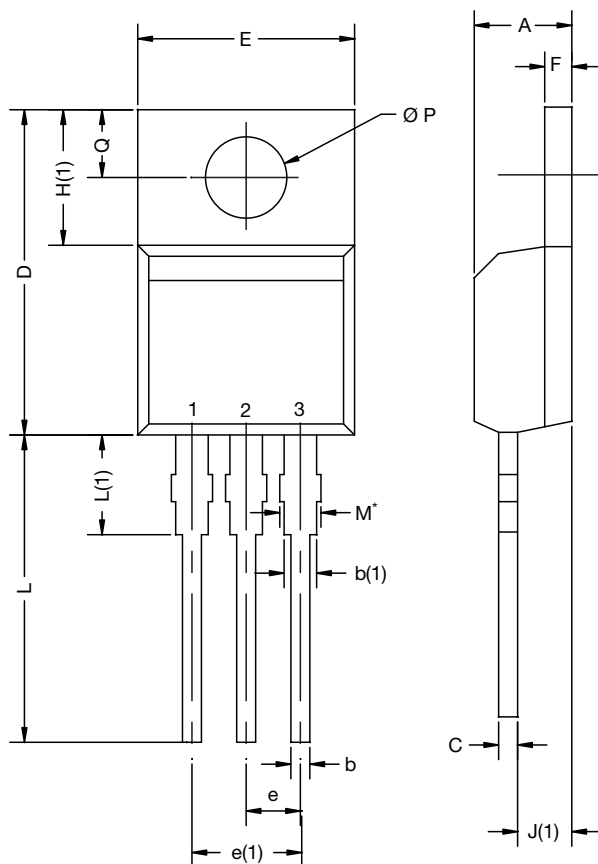

**Note**

a.  $V_{GS} = 5 V$  for logic level devices

**Fig. 18 - For N-Channel**

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## TO-220-1



| DIM.            | MILLIMETERS |       | INCHES |       |
|-----------------|-------------|-------|--------|-------|
|                 | MIN.        | MAX.  | MIN.   | MAX.  |
| A               | 4.24        | 4.65  | 0.167  | 0.183 |
| b               | 0.69        | 1.02  | 0.027  | 0.040 |
| b(1)            | 1.14        | 1.78  | 0.045  | 0.070 |
| c               | 0.36        | 0.61  | 0.014  | 0.024 |
| D               | 14.33       | 15.85 | 0.564  | 0.624 |
| E               | 9.96        | 10.52 | 0.392  | 0.414 |
| e               | 2.41        | 2.67  | 0.095  | 0.105 |
| e(1)            | 4.88        | 5.28  | 0.192  | 0.208 |
| F               | 1.14        | 1.40  | 0.045  | 0.055 |
| H(1)            | 6.10        | 6.71  | 0.240  | 0.264 |
| J(1)            | 2.41        | 2.92  | 0.095  | 0.115 |
| L               | 13.36       | 14.40 | 0.526  | 0.567 |
| L(1)            | 3.33        | 4.04  | 0.131  | 0.159 |
| $\varnothing P$ | 3.53        | 3.94  | 0.139  | 0.155 |
| Q               | 2.54        | 3.00  | 0.100  | 0.118 |

ECN: E21-0621-Rev. D, 04-Nov-2021  
DWG: 6031

### Note

- $M^*$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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